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FAN2500

100 mA CMOS LDO Regulator

Features

- Ultra-Low Power Consumption
- 100 mV Dropout Voltage at 100 mA
- 25 μ A Ground Current at 100 mA
- Enable / Shutdown Control
- SOT23-5 package
- Thermal Limiting
- 300 mA Peak Current

Applications

- Mobile Phones and Accessories
- Portable Cameras and Video Recorders
- Laptop, Notebook, and Palmtop Computers

Description

The FAN2500 micropower low-dropout voltage regulator utilizes CMOS technology to offer a new level of cost-effective performance in mobile handsets, laptop and notebook portable computers, and other portable devices. Features include extremely low power consumption, low shutdown current, low dropout voltage, exceptional loop stability able to accommodate a wide variety of external capacitors, and a compact SOT23-5 surface-mount package. The FAN2500 offers significant improvements over older BiCMOS designs and is pin-compatible with many popular devices. The output is thermally protected against overload.

FAN2500: pin 4 – ADJ, allows the user to adjust the output voltage over a wide range using an external voltage divider.

FAN2500-XX: pin 4 – BYP, to which a bypass capacitor may be connected for optimal noise performance. Output voltage is fixed, indicated by the suffix XX.

The standard fixed output voltages available are 2.5 V, 3.0 V, and 3.3 V.

Ordering Information

Part Number	V _{OUT}	Pin 4 Function	Top Mark	Package	Packing Method
FAN2500S25X	2.5	Bypass	ACE	SOT-23 5L	Tape and Reel
FAN2500S30X	3.0	Bypass	ACW	SOT-23 5L	Tape and Reel
FAN2500S33X	3.3	Bypass	AC3	SOT-23 5L	Tape and Reel
FAN2500SX	Adj.	Adjust	ACA	SOT-23 5L	Tape and Reel

Tape and Reel Information

Quantity	Reel Size	Width
3000	7 inches	8 mm

Block Diagram

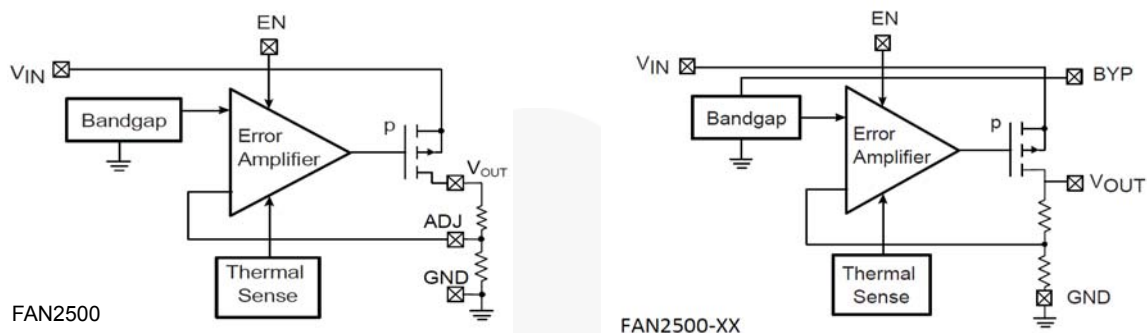


Figure 1. Block Diagram

Pin Configuration

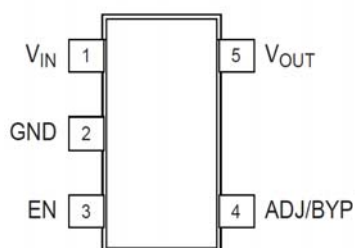


Figure 2. Pin Configuration

Pin No.	FAN2500	FAN2500-XX
1.	V_{IN}	V_{IN}
2.	GND	GND
3.	EN	EN
4.	ADJ	BYP
5.	V_{OUT}	V_{OUT}

Pin Descriptions

Pin Name	Pin No.	Type	Functional Description
ADJ	4	Input	FAN2500 Adjust Ratio of potential divider from V_{OUT} to ADJ determines output voltage
BYP	4	Passive	FAN2500-XX Bypass Connect a 470 pF capacitor for noise reduction
EN	3	Digital Input	Enable 0: Shutdown V_{OUT} 1: Enable V_{OUT}
V_{IN}	1	Power In	Voltage Input Supply voltage input
V_{OUT}	5	Power Out	Voltage Output Regulated output voltage
GND	2	Power	Ground

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Parameter	Min.	Max.	Unit
Power Supply Voltages			
V _{IN} (Measured to GND)	0	7	V
Enable Input (EN)			
Applied Voltage (Measured to GND) ⁽²⁾	0	7	V
Power			
Dissipation ⁽³⁾	Internally Limited		
Temperature			
Junction	-65	150	°C
Lead Soldering (5 s)		260	°C
Storage	-65	150	°C
Electrostatic Discharge ⁽⁴⁾	4		kV

Notes:

- Functional operation under any of these conditions is NOT implied. Performance and reliability are guaranteed only if Recommended Operating Conditions are not exceeded.
- Applied voltage must be current limited to specified range.
- Based upon thermally limited junction temperature:

$$P_D = \frac{T_{J(max)} - T_A}{\theta_{JA}}$$

- Human Body Model is 4 kV minimum using Mil Std. 883E, method 3015.7. Machine Model is 400 V minimum using JEDEC method A115-A.

Recommended Operating Conditions

The recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Nom.	Max.	Unit
V _{IN}	Input Voltage Range	2.7		6.5	V
V _{EN}	Enable Input Voltage	0		V _{IN}	V
T _J	Junction Temperature	-40		+125	°C
θ _{JA}	Thermal Resistance, Junction to Air		220		°C/W
θ _{JC}	Thermal Resistance, Junction to Case		130		°C/W

Electrical Characteristics^(5, 6)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
Regulator						
V_{DO}	Drop-Out Voltage	$I_{OUT} = 100\ \mu A$		2.5	4.0	mV
		$I_{OUT} = 50\ mA$		50	75	mV
		$I_{OUT} = 100\ mA$		100	140	mV
ΔV_O	Output Voltage Accuracy		-2		2	%
ΔV_{REF}	Reference Voltage Accuracy, Adjustable Mode		1.24	1.32	1.40	V
$\Delta V_O^{(7)}$	Output Voltage Accuracy, Adjustable Mode		-6		6	%
I_{GND}	Ground Pin Current	$I_{OUT} = 100\ mA$			50	μA
Protection						
	Current Limit	Thermally Protected				
I_{GSD}	Shutdown Current	$EN = 0\ V$			1	μA
T_{SH}	Thermal Protection Shutdown Temperature		150			$^{\circ}C$
Enable Input						
V_{IL}	Logic Low Voltage			1.2	0.4	V
V_{IH}	Logic High Voltage		2.0	1.4		V
I_{IH}	Input Current High				1	μA
I_I	Input Current Low				1	μA

Switching Characteristics^(5, 6)

Parameter	Max.	Unit
Enable Input⁽⁸⁾		
Response Time	500	μsec

Performance Characteristics^(5, 6)

Symbol	Parameter	Conditions	Typ.	Max.	Unit
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	$V_{IN} = (V_{OUT} + 1)\ \text{to}\ 6.5\ V$	0.3		% / V
$\frac{\Delta V_{OUT}}{V_{OUT}}$	Load Regulation	$I_{OUT} = 0.1\ \text{to}\ 100\ mA$	1.0	2.0	%
e_N	Output Noise	$f = 10\ Hz\ \text{to}\ 1\ kHz\ \text{at}\ V_{IN},$ $C_{OUT} = 10\ \mu F,$ $C_{BYP} = 0.01\ \mu F$	< 7.00		$\mu V\ /\sqrt{Hz}$
		$f > 10\ kHz\ \text{at}\ V_{IN},$ $C_{OUT} = 10\ \mu F,$ $C_{BYP} = 0.01\ \mu F$	< 0.01		
PSRR	Power Supply Rejection	$f = 120\ Hz\ \text{at}\ V_{IN},$ $C_{OUT} = 10\ \mu F,$ $C_{BYP} = 0.01\ \mu F$	43		dB

Notes:

- Unless otherwise stated; $T_A = 25^{\circ}C$, $V_{IN} = V_{OUT} + 1\ V$, $I_{OUT} = 100\ \mu A$, and $V_{IH} > 2.0\ V$.
- Bold values indicate $-40 \leq T_J \leq 125^{\circ}C$.
- The adjustable version has a band-gap voltage range of 1.24 V to 1.40 V with a nominal value of 1.32 V.
- When using repeated cycling.

Typical Performance Characteristics

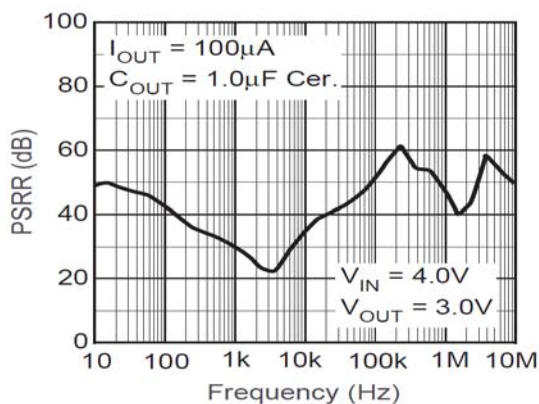


Figure 3. Power Supply Rejection Ratio

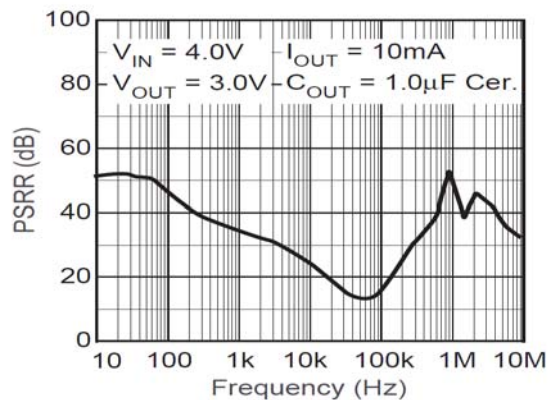


Figure 4. Power Supply Rejection Ratio

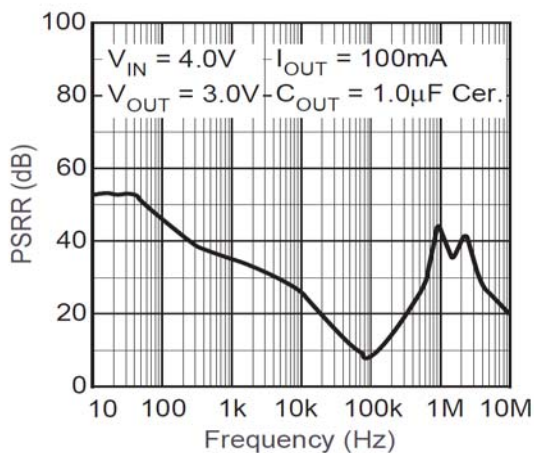


Figure 5. Power Supply Rejection Ratio

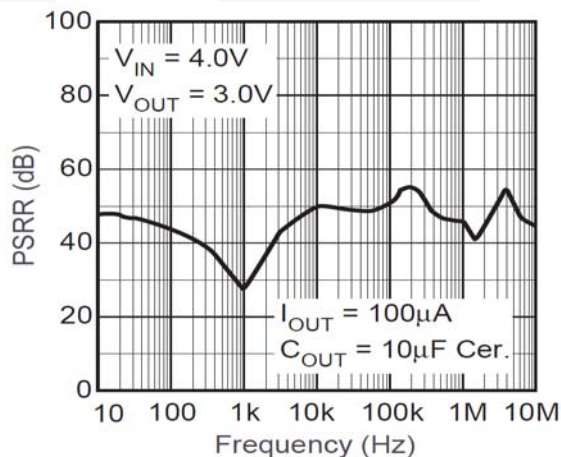


Figure 6. Power Supply Rejection Ratio

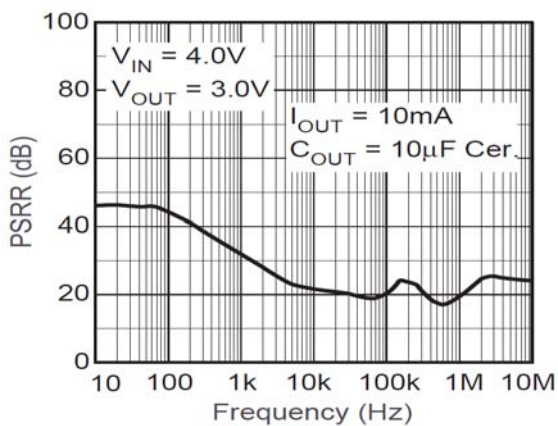


Figure 7. Power Supply Rejection Ratio

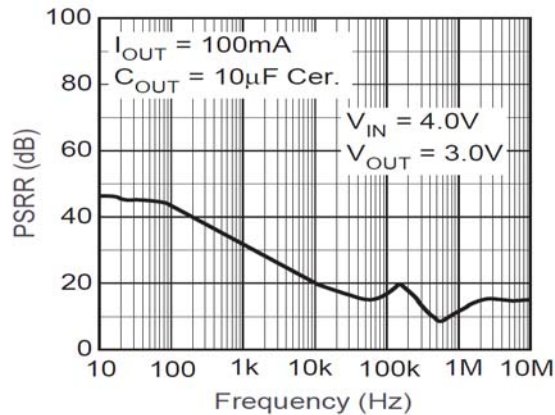


Figure 8. Power Supply Rejection Ratio

Typical Performance Characteristics (Continued)

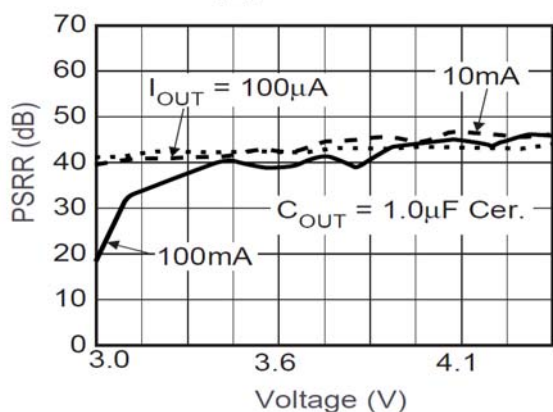


Figure 9. PSRR vs. Voltage Drop

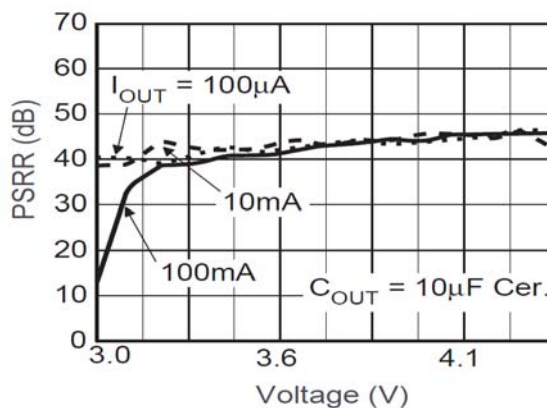


Figure 10. PSRR vs. Voltage Drop

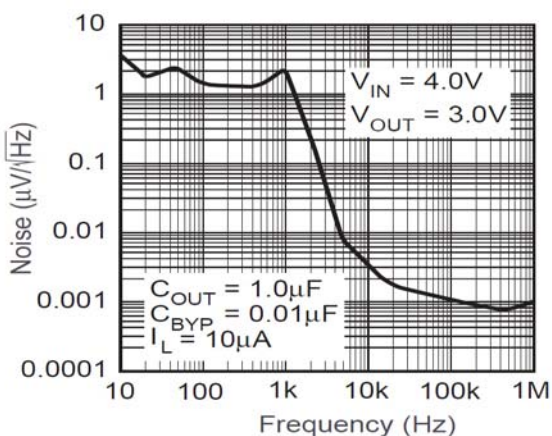


Figure 11. Noise Performance

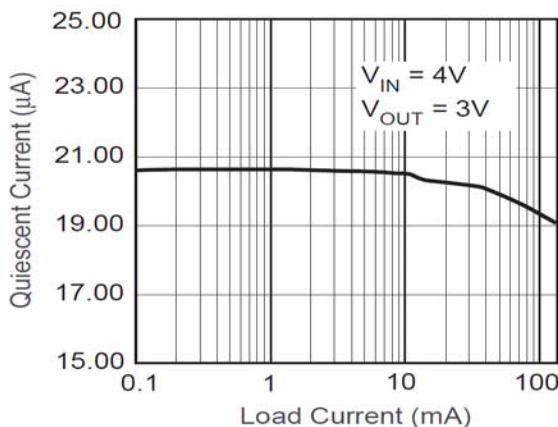


Figure 12. Ground Pin Current

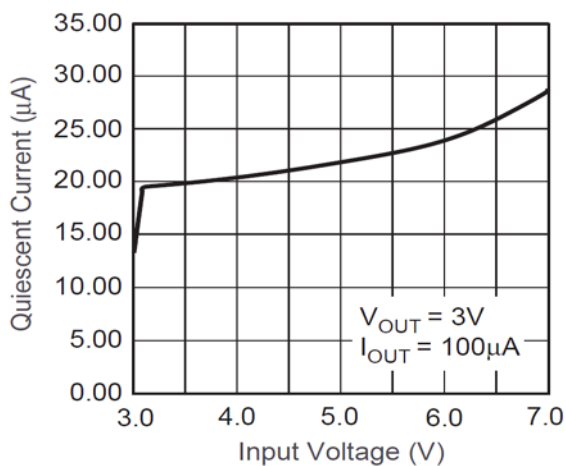


Figure 13. Ground Pin Current

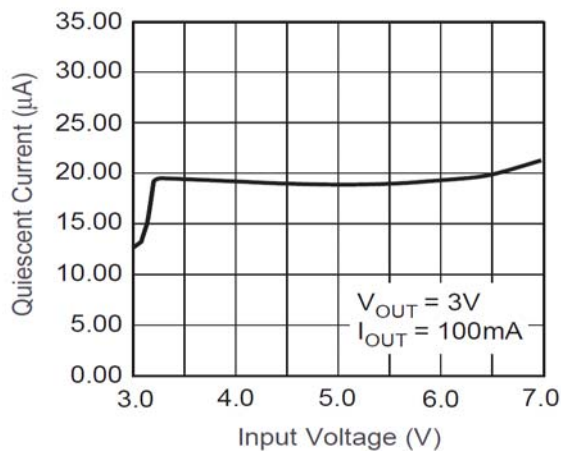


Figure 14. Ground Pin Current

Typical Performance Characteristics (Continued)

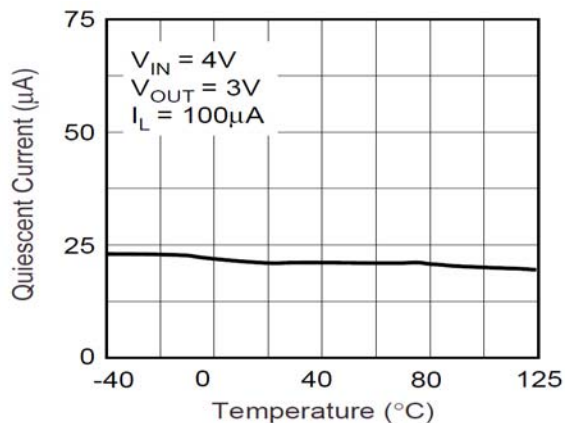


Figure 15. Ground Pin Current

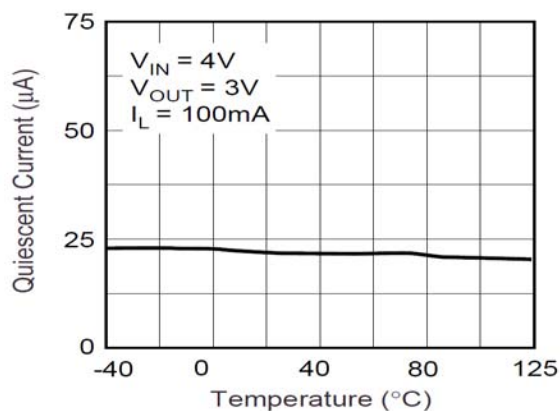


Figure 16. Ground Pin Current

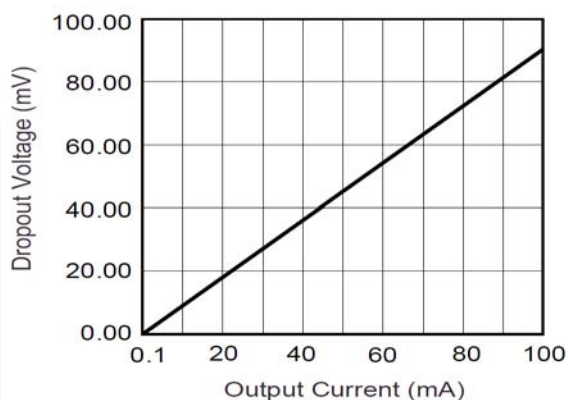


Figure 17. Dropout Voltage

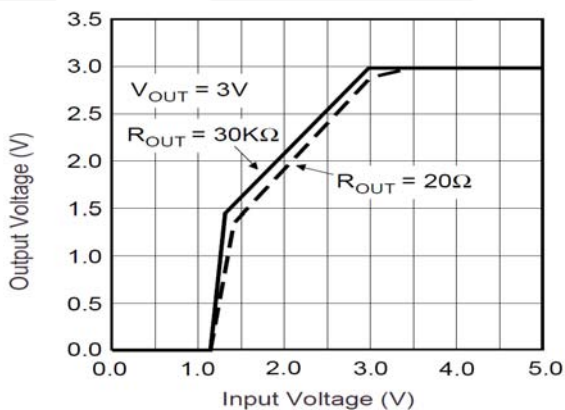


Figure 18. Dropout Characteristics

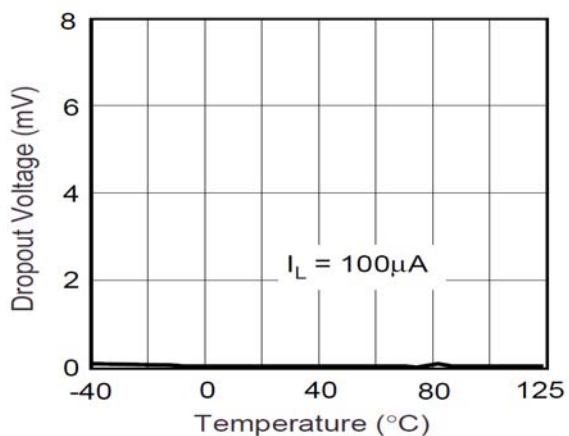


Figure 19. Dropout Voltage

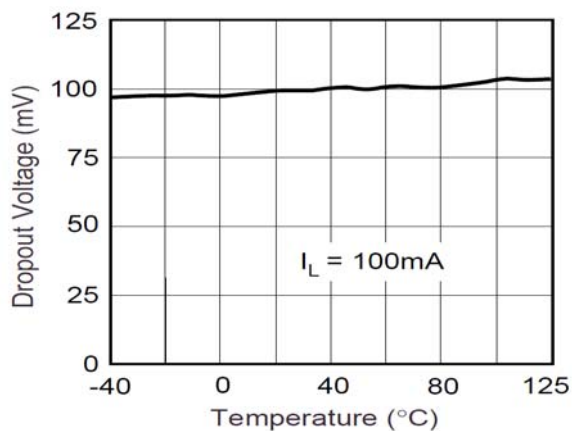


Figure 20. Dropout Voltage

Typical Performance Characteristics (Continued)

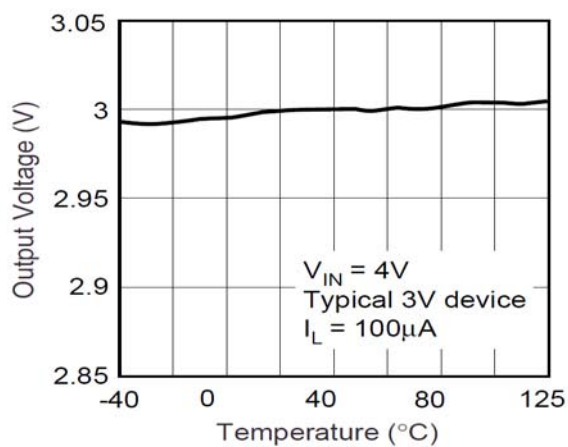


Figure 21. Output Voltage vs. Temperature

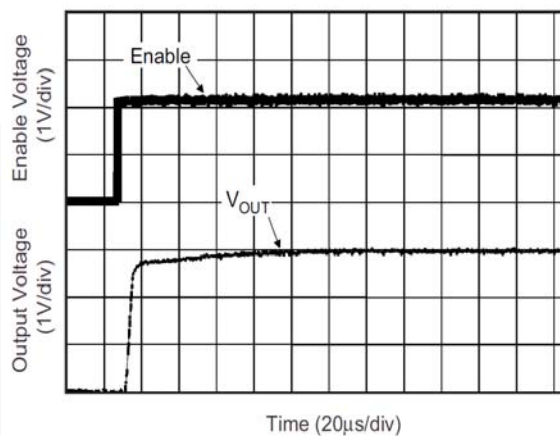


Figure 22. Enable Pin Delay

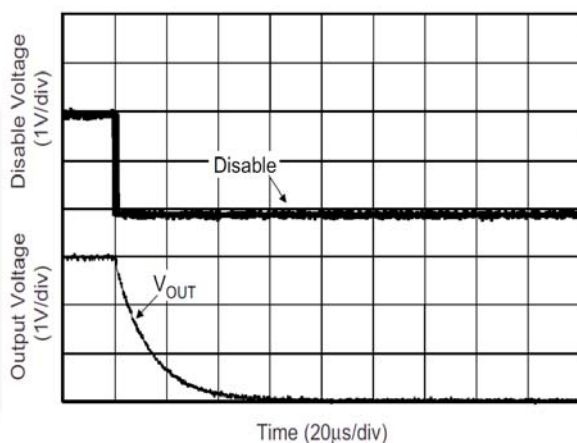


Figure 23. Shutdown Delay

Functional Description

Designed utilizing CMOS process technology, the FAN2500 is carefully optimized for use in compact battery-powered devices. The FAN2500 offers a unique combination of low power consumption, extremely low dropout voltages, high tolerance for a variety of output capacitors, and the ability to disable the output to less than 1 μA under user control. In the circuit, a difference amplifier controls the current through a series-pass P-channel MOSFET, comparing the load voltage at the output with an onboard low-drift band-gap reference. The series resistance of the pass P-channel MOSFET is approximately 1 Ω , resulting in an unusually low dropout voltage under load compared to older bipolar pass-transistor designs.

Protection circuitry is provided onboard for overload conditions. If the device reaches temperatures exceeding the specified maximums, an onboard circuit shuts down the output and it remains suspended until it has cooled before re-enabling. The user can shut down the device using the Enable control pin at any time.

Careful design of the output regulator amplifier assures loop stability over a wide range of ESR values in the external output capacitor. A wide range of values and types can be accommodated, allowing the user to select a capacitor meeting space, cost, and performance requirements; and still enjoy reliable operation over temperature, load, and tolerance variations.

Depending on the model selected, a number of control and status functions are available to enhance the operation of the LDO regulator. An Enable pin, available on all devices, allows the user to shut down the regulator output to conserve power, reducing supply current to less than 1 μA . The adjustable-voltage versions of the device utilize pin 4 to connect to an external voltage divider that feeds back to the regulator error amplifier, thereby setting the voltage as desired. Two other functions are available at pin 4 in the fixed-voltage versions: in noise-sensitive applications, an external bypass capacitor connection is provided that allows the user to achieve optimal noise performance at the output, while the error output functions as a diagnostic flag to indicate that the output voltage has dropped more than 5% below the nominal fixed voltage.

Applications Information

External Capacitors – Selection

FAN2500 supports a wide variety of capacitors compared to other LDO products. An innovative design approach offers significantly reduced sensitivity to ESR (Equivalent Series Resistance), which degrades regulator loop stability in older designs. While the improvements greatly simplify the design task, capacitor quality still must be considered to achieve optimal circuit performance.

In general, ceramic capacitors offer superior ESR performance at a lower cost and a smaller case size than tantalum. Those with X7R or Y5V dielectric offer the best temperature coefficient characteristics. The combination of tolerance and variation over temperature in some capacitor types can result in significant variations, resulting in unstable performance over rated conditions.

Input Capacitor

An input capacitor of 2.2 μF (nominal value) or greater, connected between the Input pin and ground, located in close proximity to the device, improves transient response and noise rejection. Higher values offer superior input ripple rejection and transient response. An input capacitor is recommended when the input source, either a battery or a regulated AC voltage, is located far from the device. Any good-quality ceramic, tantalum, or metal film capacitor gives acceptable performance; however, tantalum capacitors with a surge current rating appropriate to the application must be selected to avoid catastrophic failure.

Output Capacitor

An output capacitor is required to maintain regulator loop stability. Unlike many other LDO regulators, the FAN2500 is nearly insensitive to output capacitor ESR. Stable operation is achieved with a wide variety of capacitors with ESR values ranging from 10 m Ω to 10 Ω or more. Tantalum, aluminum electrolytic, or multilayer ceramic can be used. A nominal value of at least 1 μF is recommended.

Bypass Capacitor (FAN2500 Only)

In the fixed-voltage configuration, connecting a capacitor between the Bypass pin and ground can significantly reduce noise on the output. Values ranging from 470 pF to 10 nF can be used, depending on the sensitivity to output noise in the application.

At the high-impedance Bypass pin, care must be taken in the circuit layout to minimize noise pickup and capacitors must be selected to minimize current loading (leakage). Noise pickup from external sources can be considerable. Leakage currents into the Bypass pin directly affect regulator accuracy and should be kept as low as possible; high-quality ceramic and film types are recommended for their low leakage characteristics. Cost-sensitive applications not concerned with noise can omit this capacitor.

Control Functions

Enable Pin

Applying a voltage of 0.4 V or less at the Enable pin disables the output, reducing the quiescent output current to less than 1 μA ; while a voltage of 2.0 V or greater enables the device. If this shutdown function is not needed, the pin can be connected to the V_{IN} pin. Allowing this pin to float causes erratic operation.

Thermal Protection

FAN2500 can supply high peak output currents of up to 1 A for brief periods. However, this output load causes the device temperature to exceed maximum ratings due to power dissipation. During output overload conditions, when the die temperature exceeds the shutdown limit temperature of 150°C, onboard thermal protection disables the output until the temperature drops below this limit, at which point the output is re-enabled. During a thermal shutdown situation, the user may assert the power-down function at the Enable pin, reducing power consumption to the minimum level $I_{GND} \cdot V_{IN}$.

Thermal Characteristics

FAN2500 can supply 100 mA at the specified output voltage with an operating die (junction) temperature of up to 125°C. Once the power dissipation and thermal resistance is known, the maximum junction temperature of the device can be calculated. While the power dissipation is calculated from known electrical parameters, the thermal resistance is a result of the thermal characteristics of the compact SOT23-5 surface-mount package and the surrounding PC board copper to which it is mounted.

The power dissipation is equal to the product of the input to output voltage differential and the output current, plus the ground current multiplied by the input voltage, or:

$$P_D = (V_{IN} - V_{OUT})I_{OUT} + V_{IN}I_{GND}$$

The ground pin current, I_{GND} , can be found in the charts provided in the Electrical Characteristics section.

The relationship describing the thermal behavior of the package is:

$$P_{D(max)} = \left\{ \frac{T_{J(max)} - T_A}{\theta_{JA}} \right\}$$

where $T_{J(max)}$ is the maximum allowable junction temperature of the die, which is 125°C, and T_A is the ambient operating temperature. θ_{JA} is dependent on the surrounding PC board layout and can be empirically obtained. While the θ_{JC} (junction-to-case) of the SOT23-5 package is specified at 130°C/W, the θ_{JA} of the minimum PWB footprint is at least 235°C/W. This can be improved by providing a heat sink of surrounding copper ground on the PCB.

Depending on the size of the copper area, the resulting θ_{JA} can range from approximately 180°C/W for one square inch to nearly 130°C/W for four square inches. The addition of backside copper with through-holes, stiffeners, and other enhancements can reduce this value. The heat contributed by the dissipation of other devices nearby must be included in design considerations.

Once the limiting parameters in these two relationships have been determined, the design can be modified to ensure that the device remains within specified operating conditions at all times.

If overload conditions are not considered, it is possible for the device to enter a thermal cycling loop, in which the circuit enters a shutdown condition, cools, re-enables, and then again overheats and shuts down repeatedly due to an unmanaged fault condition.

Operational of Adjustable Version

The adjustable version of the FAN2500 includes an input pin, ADJ, which allows the user to select an output voltage ranging from 1.8 V to near V_{IN} , using an external resistor divider. The voltage V_{ADJ} presented to the ADJ pin is fed to the onboard error amplifier, which adjusts the output voltage until V_{ADJ} is equal to the onboard bandgap reference voltage of 1.32 V (typ). The equation is:

$$V_{OUT} = 1.32V \times \left[1 + \frac{R_{upper}}{R_{lower}} \right]$$

The total value of the resistor chain should not exceed 250 kΩ total to keep the error amplifier biased during no-load conditions. Programming output voltages very near V_{IN} need to allow for the magnitude and variation of the dropout voltage V_{DO} over load, supply, and temperature variations. Note that the low-leakage MOSFET input to the CMOS error amplifier induces no bias current error to the calculation.

General PCB Layout Considerations

To achieve the full performance of the device, careful circuit layout and grounding technique must be observed. Establishing a small local ground, to which the GND pin, the output, and bypass capacitors are connected; is recommended. The input capacitor should be grounded to the main ground plane. The quiet local ground is routed back to the main ground plane using feed-through vias. In general, the high-frequency compensation components (input, bypass, and output capacitors) should be located as close to the device as possible. The proximity of the output capacitor is especially important to achieve optimal noise compensation from the onboard error amplifier, especially during high load conditions. A large copper area in the local ground provides the heat sinking discussed above when high power dissipation significantly increases the temperature of the device.

Component-side copper provides significantly better thermal performance for this surface-mount device, compared to that obtained when using only copper planes on the underside.

Physical Dimensions

SOT-23

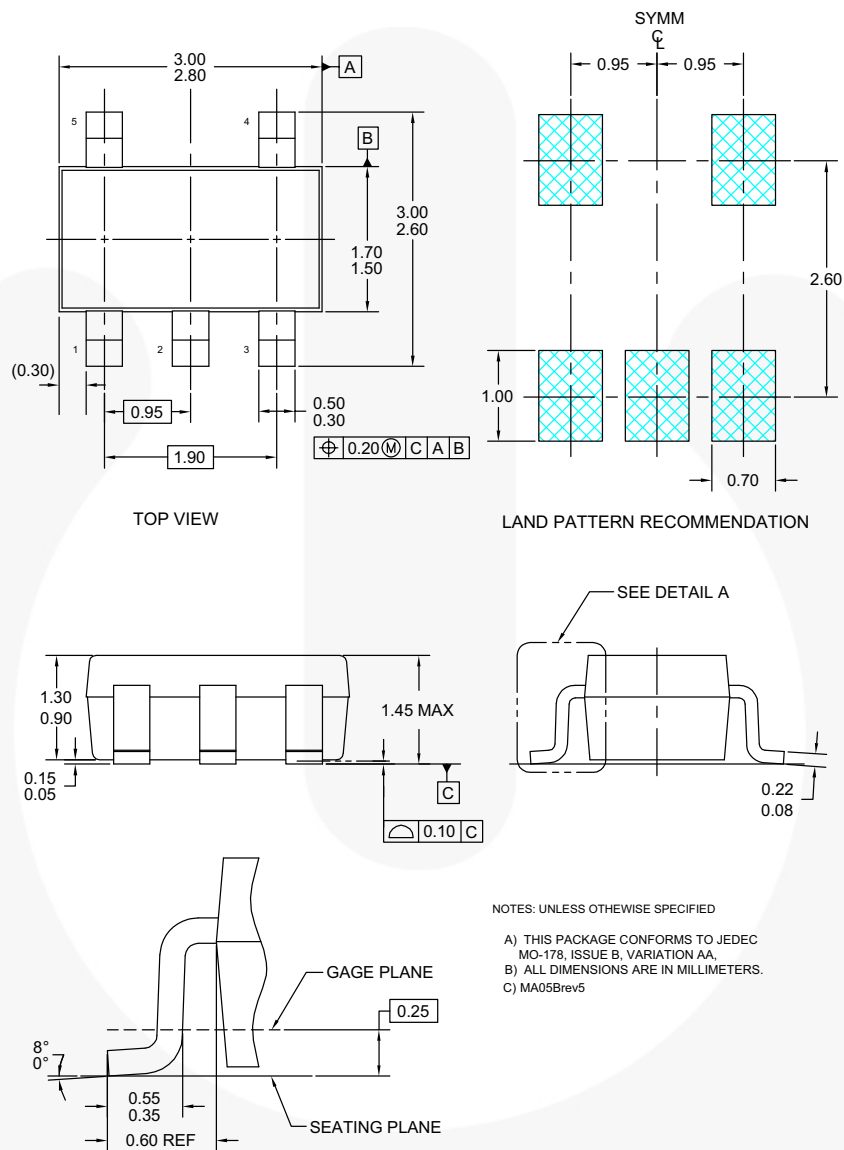


Figure 24. 5-LEAD, SOT-23, JEDEC MO-178, 1.6 mm

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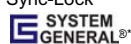



For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area:

http://www.fairchildsemi.com/packaging/tr/SOT23-5L_tr.pdf



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